

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









STP22NF03L

N-channel 30 V, 0.0038 Ω, 22 A, TO-220 STripFET™ II Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D
STP22NF03L	30 V	< 0.05 Ω	22 A

- Exceptional dv/dt capability
- Low gate charge at 100°C
- Application oriented characterization
- 100% avalanche tested

Application

■ Switching applications

Description

This Power MOSFET is the latest development of STMicroelectronics unique "single feature size" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

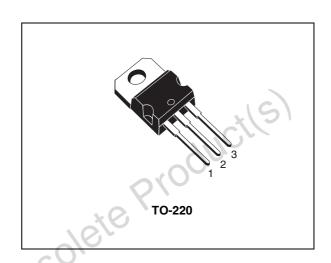


Figure 1. Internal schematic diagram

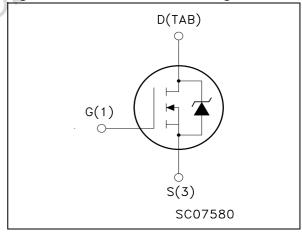


Table 1. Device summary

	Order code	Marking	Package	Packaging
Ī	STP22NF03L	P22NF03L@	TO-220	Tube

Contents STP22NF03L

Contents

1	Electrical ratings 3
2	Electrical characteristics
3	Test circuit
4	Package mechanical data
5	Revision history11
005	Electrical characteristics

STP22NF03L Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{DGR}	Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	30	V
V _{GS}	Gate- source voltage	± 15	V
I _D	Drain current (continuous) at T _C = 25 °C	22	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	16	А
I _{DM} ⁽¹⁾	Drain current (pulsed)	88	Α
P _{tot}	Total dissipation at T _C = 25 °C	45	W
	Derating factor	0.3	W/°C
dv/dt ⁽²⁾	Peak diode recovery voltage slope	6	V/ns
E _{AS} (3)	Single pulse avalanche energy	200	mJ
T _{stg}	Storage temperature	-55 to 175	°C
Tj	Max. operating junction temperature	-55 to 175	C

^{1.} Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	3.33	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	62.5	°C/W
TJ	Maximum lead temperature for soldering purpose	300	°C

 $^{2. \}quad I_{SD} \ \leq \ 22 \ A, \ di/dt \ \leq \ 300 \ A/\mu s, \ V_{DD} \ \leq \ V_{(BR)DSS}, \ T_{j} \ \leq \ T_{JMAX}$

^{3.} Starting $T_j = 25$ °C, $I_D = 11$ A, $V_{DD} = 15$ V

STP22NF03L **Electrical characteristics**

Electrical characteristics 2

(T_{CASE} = 25 °C unless otherwise specified)

On/off states Table 4.

Parameter	Parameter Test conditions		Тур.	Max.	Unit
Drain-source breakdown voltage	$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0$	30			V
Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = max ratings V_{DS} = max ratings, T_{C} = 125 °C			1 10	μA μA
Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V		AL	±100	nA
Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1,(200		V
Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 11 \text{ A}$ $V_{GS} = 5 \text{ V}, I_D = 11 \text{ A}$		0.038 0.045	0.05 0.06	Ω Ω
Dynamic	coler	1	1		
	Drain-source breakdown voltage Zero gate voltage drain current (V _{GS} = 0) Gate-body leakage current (V _{DS} = 0) Gate threshold voltage Static drain-source on resistance	$\begin{array}{ll} \text{Drain-source} \\ \text{breakdown voltage} \\ \end{array} & \text{I}_D = 250 \; \mu\text{A}, \; V_{GS} = 0 \\ \\ \text{Zero gate voltage} \\ \text{drain current} \; (V_{GS} = 0) \\ \end{array} & \begin{array}{ll} V_{DS} = \text{max ratings} \\ V_{DS} = \text{max ratings}, \\ T_C = 125 \; ^{\circ}\text{C} \\ \\ \text{Gate-body leakage} \\ \text{current} \; (V_{DS} = 0) \\ \\ \text{Gate threshold voltage} \\ \end{array} & \begin{array}{ll} V_{GS} = \pm 20 \; \text{V} \\ \\ V_{DS} = V_{GS}, \; \text{I}_D = 250 \; \mu\text{A} \\ \\ \text{Static drain-source on} \\ \text{resistance} \\ \end{array} & \begin{array}{ll} V_{GS} = 10 \; \text{V}, \; \text{I}_D = 11 \; \text{A} \\ \\ V_{GS} = 5 \; \text{V}, \; \text{I}_D = 11 \; \text{A} \\ \end{array}$	$\begin{array}{llllllllllllllllllllllllllllllllllll$	$\begin{array}{llllllllllllllllllllllllllllllllllll$	$\begin{array}{llllllllllllllllllllllllllllllllllll$

Table 5. **Dynamic**

	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	9 _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15 V _, I _D = 11 A		7		S
	C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0		330 90 40		pF pF pF
7/6	t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} = 15 V, I_D = 11 A R_G = 4.7 Ω V_{GS} = 5 V (see <i>Figure 13</i>)		13 4 12 5		ns ns ns
Opso	Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} = 24 V, I_{D} = 22 A, V_{GS} = 5 V (see <i>Figure 14</i>)		6.5 3.6 2	9	nC nC nC

^{1.} Pulsed: Pulse duration = 300 μs, duty cycle 1.5%.

Table 6. Source drain diode

	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				22 88	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 22 A, V _{GS} = 0			1.5	V
t _{rr}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 22 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s},$ $V_{DD} = 15 \text{ V}, T_j = 150 ^{\circ}\text{C}$ (see <i>Figure 15</i>)		30 18 1.2		ns nC A
 Pulse wid Pulsed: P 	th limited by safe operating are ulse duration = 300 µs, duty cy	a. cle 1.5%			cile	
		<	SYC	0,3		
		alete				
		00501				
	16)	0.				
	Auci(s)	0.				
O,	oduci(s)					
ete P	(oduci(s)					
ste P	(oduci(s)	V _{DD} = 15 V, T _j = 150 °C (see <i>Figure 15</i>) a. cle 1.5%				

Electrical characteristics STP22NF03L

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

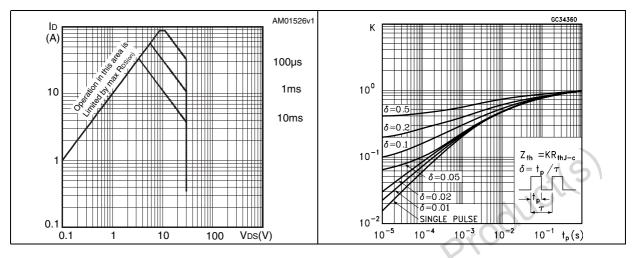


Figure 4. Output characteristics

Figure 5. Transfer characteristics

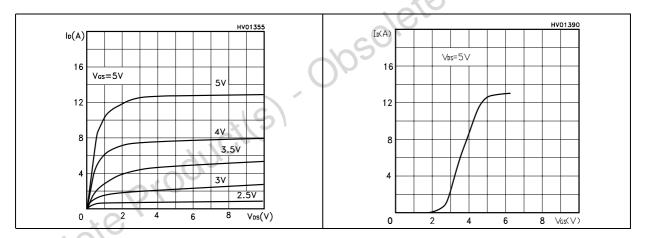


Figure 6. Transconductance

Figure 7. Static drain-source on resistance

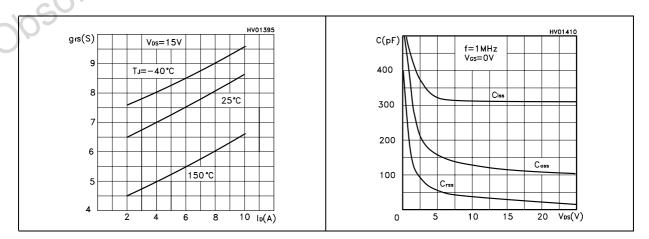


Figure 8. Gate charge vs. gate-source voltage Figure 9. Capacitance variations

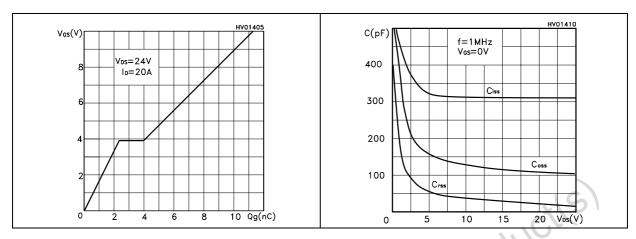


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs. vs. temperature temperature

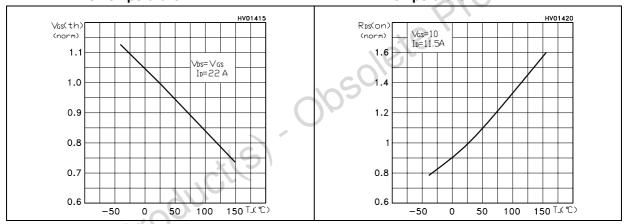
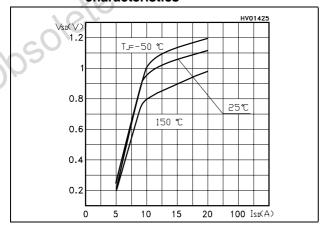


Figure 12. Source-drain diode forward characteristics



Test circuit STP22NF03L

3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

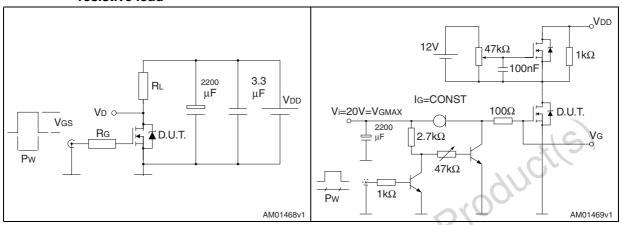


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

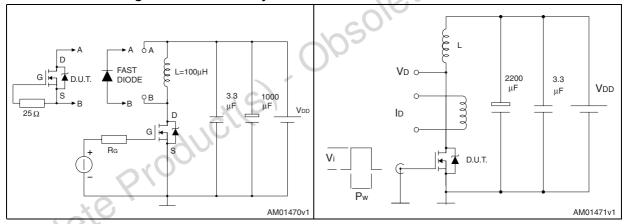
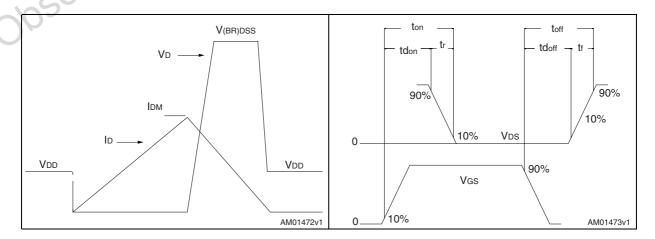


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



577

4 Package mechanical data

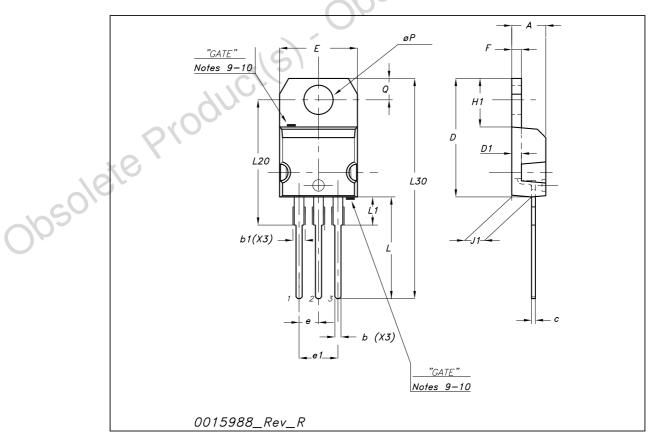
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Produci(s). Obsolete Produci(s)

577

TO-220 mechanical data

Dim		mm			inch	
Dim	Min	Тур	Max	Min	Тур	Max
А	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
С	0.48		0.70	0.019		0.027
D	15.25		15.75	0.6		0.62
D1		1.27			0.050	
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094	34	0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048	11/10	0.051
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40		0	0.645	
L30		28.90	18,	P	1.137	
ØP	3.75		3.85	0.147		0.151
Q	2.65	100	2.95	0.104		0.116



STP22NF03L Revision history

5 Revision history

Table 7. Document revision history

	Date	Revision	Changes
	09-Sep-2004	1	Datasheet according to PCN DSG-TRA/04/532
	09-Aug-2006	2	New template, no content change
	20-Feb-2007	3	Typo mistake on page 1
	03-Sep-2007	4	Figure 2: Safe operating area has been update.
	08-Oct-2008	5	Figure 2: Safe operating area has been update.
005018	Ryod	Jucils	Figure 2: Safe operating area has been update. Figure 2: Safe operating area has been update.

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2008 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

577